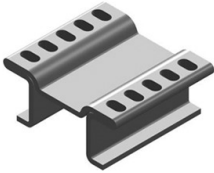


Data sheet Product FK 251 06 LF PAK



Board Level heatsinks>Heatsinks for D PAK and others

- direct PCB mounting thru solderable surface
available standard packing: loose parts (**bulk goods**) or reel (**TR = tape and reel**)
- **tape width:** 24 mm, **reel diameter:** 330 mm, **quantity:** FK 250 06 = 450, FK 250 08 = 450, FK 250 10 = 350
- **tape width:** 24 mm, **reel diameter:** 330 mm, **quantity:** FK 251 06 = 450, FK 251 08 = 350, FK 251 10 = 250

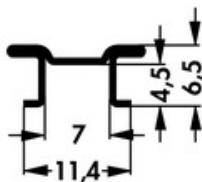
Features

for transistor:

- SOT 223
- Power SO 8
- D³ PAK (TO 268)
- Power_SO_20
- SO-14
- D² PAK (TO 263)
- Power SO 10
- D PAK (TO 252)
- SOT 669 LF PAK
- SO-16
- SO IC 8 FL MP
- SO-8
- Power SO 36

| | |
|---------------------|--------------------|
| width: | 15 mm |
| height: | 6.5 mm |
| length: | 13 mm |
| thermal resistance: | 32 K/W |
| surface: | solderable surface |
| material: | copper (Cu) |
| material thickness: | 0.6 mm |

Technical Drawing



32 K/W

